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| APPLICATION NO. | FILING DATE | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO. | CONFIDMATIONAL | |
|--|----------------|----------------------|-------------------------|------------------|--|
| 09/533,613 | 03/22/2000 | Fred E. Stanke | 21964-708 | CONFIRMATION NO. | |
| | 590 05/26/2004 | | EXAMINER | | |
| STALLMAN & POLLOCK LLP ATTN: MICHAEL A STALLMAN | | • | РНАМ, | PHAM, HOA Q | |
| | ENTO STREET | | ART UNIT | PAPER NUMBER | |
| SUITE 2200 SAN FRANCIS | SCO, CA 94111 | | 2877 | | |
| , 332 3 | | | DATE MAILED: 05/26/2004 | | |

Please find below and/or attached an Office communication concerning this application or proceeding.

| | | . O K | |
|---|--|---|-------------|
| | Application N | Applicant(s) | |
| | 09/533,613 | STANKE,ET AL. | , k |
| Office Action Summary | Examiner | Art Unit | - |
| | Hoa Q. Pham | 2877 | |
| The MAILING DATE of this c mmunicati n ap | pears n the c ver sheet w | vith the c rrespondence addre | ss |
| A SHORTENED STATUTORY PERIOD FOR REPL THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1. after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a rep If NO period for reply is specified above, the maximum statutory period Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailin earned patent term adjustment. See 37 CFR 1.704(b). | 136(a). In no event, however, may a ly within the statutory minimum of thi will apply and will expire SIX (6) MO | reply be timely filed rty (30) days will be considered timely. NTHS from the mailing date of this commu | unication. |
| Status | | | |
| 1) Responsive to communication(s) filed on 05 A | pril 2004. | | |
| | s action is non-final. | | |
| 3) Since this application is in condition for allowa | | ters, prosecution as to the me | erits is |
| closed in accordance with the practice under t | | - | |
| | • | | |
| Disposition of Claims | • | | |
| 4)⊠ Claim(s) <u>30-46</u> is/are pending in the applicatio | | • | |
| 4a) Of the above claim(s) is/are withdra | wn from consideration. | · · | |
| 5) Claim(s) is/are allowed. | | | |
| 6)⊠ Claim(s) <u>30-44</u> is/are rejected. | | | • |
| 7)⊠ Claim(s) <u>45 and 46</u> is/are objected to. | | | |
| 8) Claim(s) are subject to restriction and/o | r election requirement. | | |
| Application Papers | | | |
| 9) The specification is objected to by the Examine | ar | | |
| 10) The drawing(s) filed on is/are: a) acc | | by the Evaminer | |
| Applicant may not request that any objection to the | | | |
| Replacement drawing sheet(s) including the correct | | | 121(d) |
| 11)The oath or declaration is objected to by the Ex | | | |
| | | * | |
| Priority under 35 U.S.C. § 119 | | | |
| 12) Acknowledgment is made of a claim for foreigna) All b) Some * c) None of: | priority under 35 U.S.C. | § 119(a)-(d) or (f). | |
| | a have been received | | |
| 1. Certified copies of the priority document2. Certified copies of the priority document | | unnligation No | |
| 3. Copies of the certified copies of the prior | | · · · · · · · · · · · · · · · · · · · | |
| application from the International Bureau | | received in this National Stat | je |
| * See the attached detailed Office action for a list | • | received | |
| | or the defined copies flot | | |
| | <u></u> | <u></u> | <u></u> |
| 1) X Notice of References Cited (PTO-892) | 4) Interview 9 | Summary (PTO-413) | |
| 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) | Paper No(| s)/Mail Date | |
| 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date | 5) | nformal Patent Application (PTO-152 |) |
| | <u> </u> | | |

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DETAILED ACTION

Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 4/5/04 has been entered.

Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 3. Claims 30-42 and 44 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kodera et al (5,695,601) in view of Norton et al (5,486,701), and Hignette et al (5,191,393).

Regarding claims 30 and 40-41, Kodera et al (of record) discloses a wafer processing station (20) and a metrology station (30) apart from but coupled to the processing station wherein the metrology station comprises an ultraviolet light source (column 3, lines 30-37) illuminating a measurement region of a surface of a wafer (10). (See figure 3). Kodera et al does not explicitly teach steps of: (1) measuring spectral

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content of the broadband light beam reflected from the wafer, (2) measuring the spectral content of the broadband light beam which has not been reflected from the wafer, and determining the wafer based on the first and second measurements; however, such a feature is known in the art, for example, as taught by Norton et al. Norton et al, from the same field of endeavor, teaches steps of: (1) measuring spectral content of the broadband light beam (46) reflected from the wafer (3) by detector (93), (2) measuring the spectral content of the broadband light beam (48) which has not been reflected from the wafer by detector (95), and determining the wafer based on the first and second measurements the measurements, where the second measurement is used to correct for system characteristics (correct for lamp noise) (see column 5 line 60 through column 6 line 20). It would have been obvious to one having ordinary skill in the art at the time the invention was made to replace the optical detection unit of Kodera et al by an optical inspection system of Norton et al. The rationale for this modification would have arisen from the fact that both systems are used for measuring the thickness of the wafer; a substitution one for another is generally recognized as being within the level of ordinary skill in the art. Hignette et al teaches that the light source (22) and fiber (8) are located outside of the metrology device (2) (see figures 1 and 7) and a preliminary step of aligning (column 9, line 25 through column 10, line 12 and claim 3). It would have been obvious to one having ordinary skill in the art at the time the invention was made to include in Kodera et al and Norton et al a "preliminary alignment step" and an "optical fiber so that the light source is located outside the measuring device" as taught by Hignette et al. The rationale for this modification would have arisen from the fact that by

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aligning the wafer with respect to the optical inspection system would increase the accuracy of the measurement and locating the light source outside the device would avoid the harmful effects of the light source as suggested by Hignette et al (column 5, lines 62-68).

Regarding claim 36, Norton et al teaches that both beams (46, 48) pass through their respective spectrometer pinholes substantially parallel (column 3 lines 41-49). Thus, the first and second measurements are obtained simultaneously.

Regarding claim 37, column 1, lines 18-19 of Norton et al for UV range.

Regarding claims 38-39, see column 2, lines 4-16 of Norton et al for the use of Xenon lamp, which covers from UV to near infrared.

Regarding claim 31, see beam divider (45) in figure 1 of Norton et al.

Regarding claim 32, see mirror (16,36) in figure 2 of Norton et al.

Regarding claim 33, see objective lens (141) in figures 4-7 of Norton et al or lens (32) and self-focusing system in column 6 lines 37-44 of Hignette et al.

Regarding claims 34-35, see figure 2 of Kodera et al.

Regarding claim 42, Hignette et al teaches that the use of self-focusing system which maintains the lens at a constant altitude with respect to the object (column 6, lines 37-44).

Regarding claim 44, see pinholes (52,54) in figure 2 of Norton et al.

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4. Claim 43 is rejected under 35 U.S.C. 103(a) as being unpatentable over Kodera et al, Norton et al and Hignette et al as applied to claim 30 above, and further in view of Akamatsu (5,258,823).

Akamatsu teaches that the wafer is aligned with respect to the optical inspection on the basis of detecting the edge position of the wafer while rotatable chuck is rotated (see abstract). It would have been obvious to one having ordinary skill in the art at the time the invention was made to replace the alignment system of Hignette et al by a system of Akamatsu because they would function in the same manner.

Allowable Subject Matter

- 5. Claims 45-46 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.
- 6. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Holzapfel et al (5,872,633) discloses a method and apparatus for measuring the thickness of a layer.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Hoa Q. Pham whose telephone number is (571) 272-2426. The examiner can normally be reached on 7:30AM to 6 PM, Monday through Thursday.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Frank G. Font can be reached on (571) 272-2415. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Иоа Q. Pham

Primary Examiner Art Unit 2877

HP May 24, 2004